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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of  
**Art Bayot**

Docket Number: **TI-33355A**

Serial No.: **10/761,690**

Art Unit: **1725**

Filed: **01/20/2004**

Examiner: **TBD**

For: **A SYSTEM AND METHOD FOR ACHIEVING PLANAR ALIGNMENT...**

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<input checked="" type="checkbox"/> <b>FACSIMILE COVER SHEET</b> <input type="checkbox"/> NEW APPLICATION <input type="checkbox"/> DECLARATION (# Pages) <input type="checkbox"/> ASSIGNMENT (# Pages) <input type="checkbox"/> FORMAL DRAWINGS <input type="checkbox"/> INFORMAL DRAWINGS <input type="checkbox"/> CONTINUATION APP'N (# Pages)		<input checked="" type="checkbox"/> <b>RESPONSE TO NOTICE OF NON-COMPLIANCE (2 PGS. INCLUDING PG. 4 OF PREVIOUSLY PRESENTED AMDT.)</b>	
NAME OF INVENTOR(S): <b>ART BAYOT</b>		RECEIPT DATE & SERIAL NO.: Serial No.: <b>10/761,690</b> Conf. No: <b>3333</b>	
TITLE OF INVENTION: <b>A SYSTEM AND METHOD FOR ...</b>			
TI FILE NO.: <b>TI-33355A</b>	DEPOSIT ACCT. NO.: <b>20-0668</b>		
FAXED: <b>12/30/2005</b> DUE: <b>01/09/2006</b> ATTY/SECY: <b>YT/jsm</b>			

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DEC 30 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
PATENT APPLICATION

In re Application of:

Art Bayot

Atty. Docket: TI-33355A

Serial No.: 10/761,690

Art Unit: 1725

Filed: 01/20/2004

Examiner: TBD

For: A SYSTEM AND METHOD FOR ACHIEVING PLANAR ALIGNMENT OF A  
SUBSTRATE DURING SOLDER BALL MOUNTING FOR USE IN  
SEMICONDUCTOR FABRICATIONCommissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

## CERTIFICATE OF MAILING 37 CFR §1.8(a)

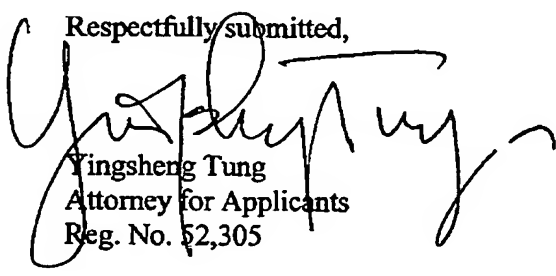
I hereby certify that this correspondence is being deposited with the  
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Jackie McBrideRESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT (37 CFR 1.121)

Sir:

In response to the Notice referenced above mailed December 9, 2005, please find enclosed page 4 of the amendment previously filed on November 23, 2005 with the underlines removed from previously presented claim 19.

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Respectfully submitted,

  
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